



# **SPECIFICATION**

(Reference sheet)

- Supplier : Samsung electro-mechanics - Samsung P/N : CL10C471JB8NNNC

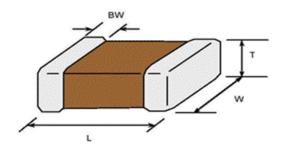
Product : Multi-layer Ceramic Capacitor
 Description : CAP, 470pF, 50V, ± 5%, C0G, 0603

## A. Samsung Part Number

<u>CL</u> <u>10</u> <u>C</u> <u>471</u> <u>J</u> <u>B</u> <u>8</u> <u>N</u> <u>N</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ 8 ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor			
2	Size	0603 (inch code)	L: 1.60 ± 0.10 mm	W: 0.80 ± 0.10 mm	
3	Dielectric	C0G	Inner electrode	Ni	
4	Capacitance	<b>470</b> pF	Termination	Cu	
(5)	Capacitance	± 5%	Plating	Sn 100% (Pb Free)	
	tolerance		Product	Normal	
6	Rated Voltage	50 V	<b>⑩</b> Special	Reserved for future use	
7	Thickness	0.80 ± 0.10 mm	① Packaging	Cardboard Type, 7" reel	

### B. Structure and dimension



Samsung P/N	Dimension(mm)				
(Lead Free)	L	W	Т	BW	
CL10C471JB8NNNC	1.60 ± 0.10	0.80 ± 0.10	0.80 ± 0.10	0.30 ± 0.20	

#### C. Samsung Reliability Test and Judgement condition

	Performance	Test condition			
Capacitance	Within specified tolerance	1 <sup>MHz</sup> ±10% / 0.5~5Vrms			
Q	1,000 min				
Insulation	10,000Mohm or 500Mohm× <i>μ</i> F	Rated Voltage 60~120 sec.			
Resistance	Whichever is smaller				
Appearance	No abnormal exterior appearance	Microscop (X10)			
Withstanding	No dielectric breakdown or	300% of the rated voltage			
Voltage	mechanical breakdown				
Temperature C0G		•			
Characteristics	(From -55 ℃ to 125 ℃, Capacitance change should be within ±30PPM/ ℃)				
Adhesive Strength	No peeling shall be occur on the	500g×F, for 10±1 sec.			
of Termination	terminal electrode				
Bending Strength	Capacitance change :	Bending to the limit (1mm)			
	within ±5% or ±0.5pF whichever is larger	with 1.0mm/sec.			
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder			
	is to be soldered newly	245±5℃, 3±0.3sec.			
		(preheating : 80~120 ℃ for 10~30sec.)			
Resistance to	Capacitance change :	Solder pot : 270±5℃, 10±1sec.			
Soldering heat	within ±2.5% or ±0.25pF whichever is larger				
	Tan δ, IR : initial spec.				
Vibration Test	Capacitance change :	Amplitude : 1.5mm			
	within ±2.5% or ±0.25pF whichever is larger	From 10Hz to 55Hz (return : 1min.)			
	Tan δ, IR : initial spec.	2hours ' 3 direction (x, y, z)			
Moisture	Capacitance change :	With rated voltage			
Resistance	within ±7.5% or ±0.75pF whichever is larger	40±2℃, 90~95%RH, 500+12/-0hrs			
	Q: 200 min				
	IR : 500Mohm or 25Mohm × $\mu$ F				
	Whichever is smaller				
High Temperature	Capacitance change :	With 200% of the rated voltage			
Resistance	within ±3% or ±0.3pF whichever is larger	Max. operating temperature			
	Q: 350 min	1000+48/-0hrs			
	IR : 1,000Mohm or 50Mohm × $\mu$ F				
	Whichever is smaller				
Temperature	Capacitance change :	1 cycle condition			
Cycling	within ±2.5% or ±0.25pF whichever is larger	Min. operating temperature $\rightarrow$ 25 $^{\circ}$ C			
	Tan δ, IR : initial spec.	$ ightarrow$ Max. operating temperature $ ightarrow$ 25 $^{\circ}$ C			
		5 cycle test			

<sup>\*</sup> The reliability test condition can be replaced by the corresponding accelerated test condition.

### D. Recommended Soldering method:

Reflow (Reflow Peak Temperature: 260+0/-5°C, 10sec. Max)



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.